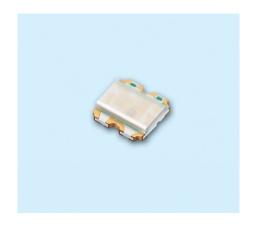


# **DATASHEET**

# SMD • B EAST1616RGBA8



#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Full-color type.
- Pb-free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

## **Description**

- The 19-337 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

## **Applications**

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

3

LifecyclePhase: Approved



## **Device Selection Guide**

Code	Chip Materials	Emitted Color	Resin Color
R6	AllnGaN	Brilliant Red	
GH	InGaN	Brilliant Green	Water Diffused
ВН	InGaN	Blue	

# Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Code	Rating	Unit
Reverse Voltage	$V_R$		5	V
Forward Current	l <sub>F</sub>		25	mA
Peak Forward Current		R6	60	
(Duty 1/10 @1KHz)	$I_{FP}$	GH	100	mA
		BH	100	
Dower Dissinction	Pd	R6 GH	60 95	mW
Power Dissipation	Fu	BH	95	111VV
Electrostatio		R6	2000	
Electrostatic	ESD	GH	150	V
Discharge(HBM)		ВН	150	
Operating Temperature	$T_{opr}$		-40 ~ +85	
Storage Temperature	Tstg		-40 ~ <b>+</b> 90	
			Reflow Solderin	g : 260 for 10 sec.
Soldering Temperature	Tsol		Hand Soldering	



# **Electro-Optical Characteristics (Ta=25**

Parameter	Symbol	Code	Min.	Тур.	Max.	Unit	Condition
		R6	72.0		140	mcd	
Luminous Intensity	lv	GH	140		285		
		BH	45.0		90.0		<u></u>
Viewing Angle	2θ <sub>1/2</sub>			120		Deg	<u></u>
		R6		632			
Peak Wavelength	р	GH		518		nm	
		BH		468			<u></u>
Dominant		R6	620		628	<u> </u>	
	d	GH	520		530	nm	
Wavelength		BH	465		470		
Construe Dadiation		R6		20			
Spectrum Radiation Bandwidth		GH		35		nm	
Bandwidth		BH		25			
	$V_{F}$	R6	1.7		2.4	v	
Forward Voltage		GH	2.7		3.7		
		BH	2.7		3.7		
	I <sub>R</sub>	R6			10		
Reverse Current		GH			50	μΑ	V <sub>R</sub> =5V
		ВН		<b>a</b> \	50		

## Note:

- 1. Tolerance of Luminous Intensity: ±11%
- Tolerance of Dominant Wavelength: ±1nm
   Tolerance of Forward Voltage: ±0.1V



## R6

## **Bin Range of Luminous Intensity**

Bin Code	Min.	Max.	Unit	Condition
Q1	72.0	90.0		
Q2	90.0	112	mcd	I <sub>F</sub> =20mA
R1	112	140		

## GH

# **Bin Range of Luminous Intensity**

Bin Code	Min.	Max.	Unit	Condition
R2	140	180		
S1	180	225	mcd	I <sub>F</sub> =20mA
S2	225	285		

# Bin Range Of Dom. Wavelength

Bin Code	Min.	Max.	Unit	Condition
X	520	525		1001
Υ	525	530	mm nm	I <sub>F</sub> =20mA

## BH

# **Bin Range of Luminous Intensity**

Bin Code	Min.	Max.	Unit	Condition
P1	45.0	57.0		
P2	57.0	72.0	mcd	I <sub>F</sub> =20mA
Q1	72.0	90.0		

#### Note:

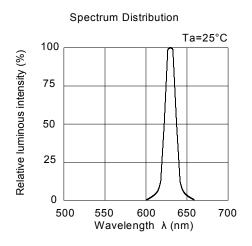
1. Tolerance of Luminous Intensity: ±11%

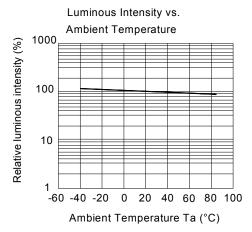
2. Tolerance of Dominant Wavelength: ±1nm

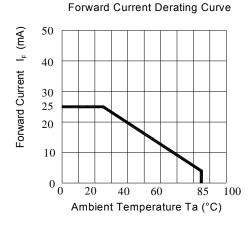


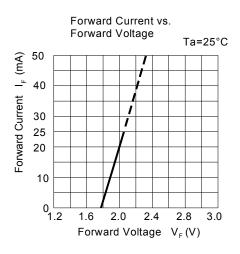
## **Typical Electro-Optical Characteristics Curves**

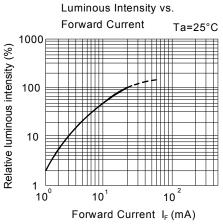
## **R6**

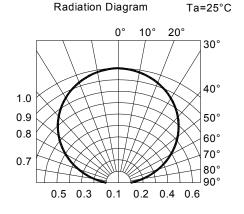








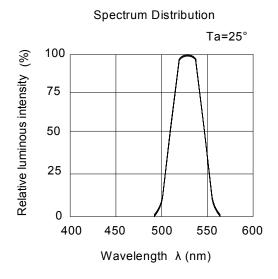


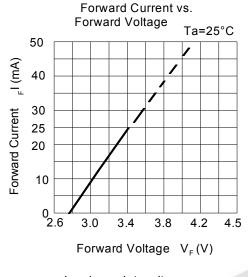


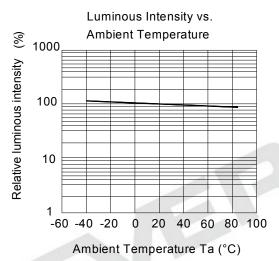


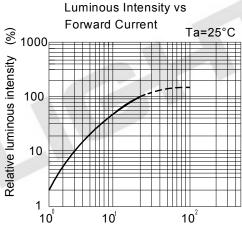
## **Typical Electro-Optical Characteristics Curves**

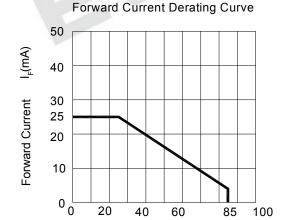
## GH







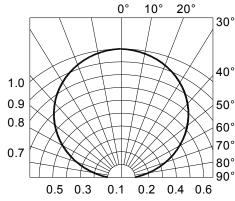




Ambient Temperature Ta (°C)



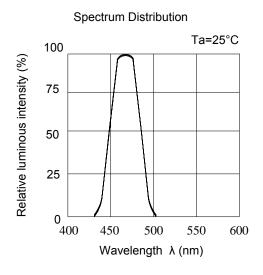
Forward Current  $I_E(mA)$ 

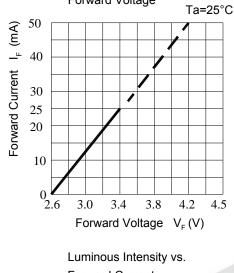




## **Typical Electro-Optical Characteristics Curves**

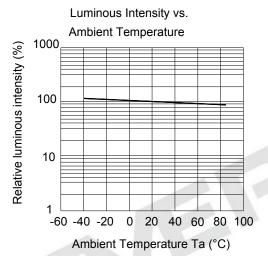
## BH

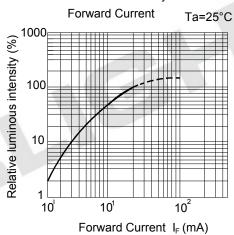


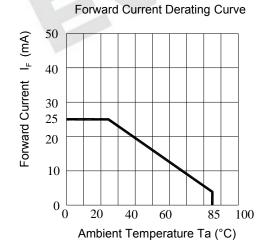


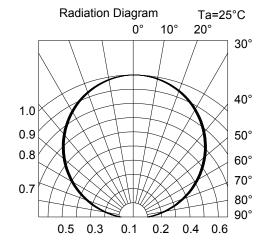
Forward Current vs.

Forward Voltage



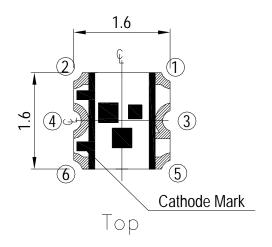


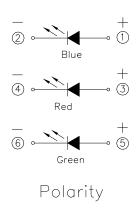


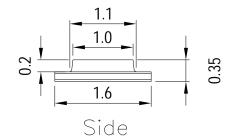




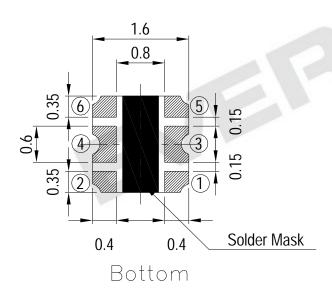
## **Package Dimension**

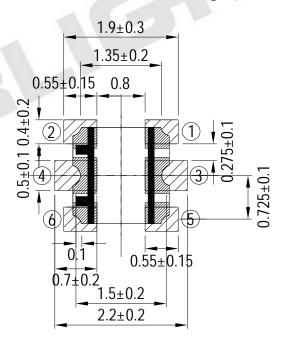






Recommend soldering pad





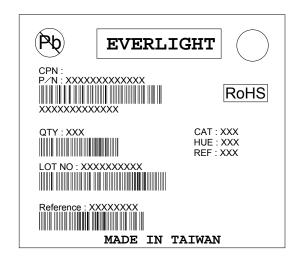
Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm



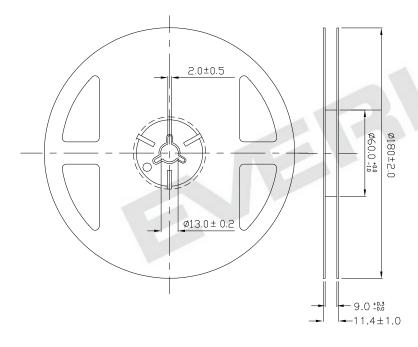
## **Moisture Resistant Packing Materials**

#### **Label Explanation**



- · CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- · CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- · REF: Forward Voltage Rank
- · LOT No: Lot Number

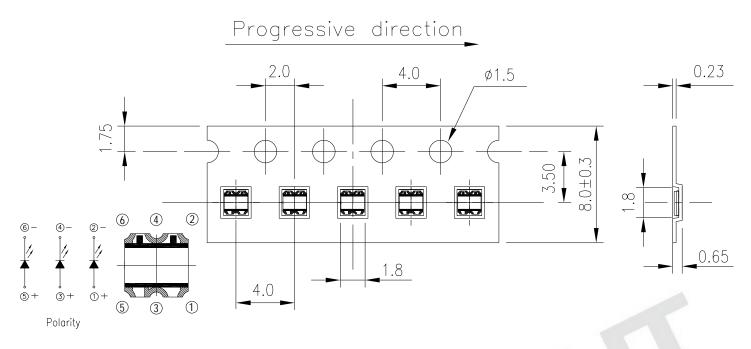
#### **Reel Dimensions**



Note: The tolerances unless mentioned is  $\pm 0.1$ mm ,Unit = mm

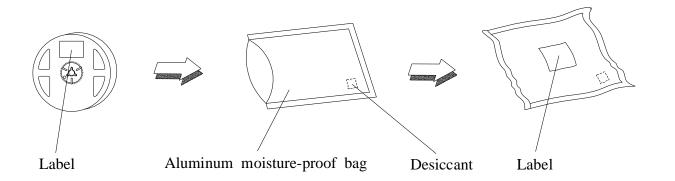


# Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is  $\pm 0.1$ mm ,Unit = mm

# **Moisture Resistant Packaging**





#### **Precautions For Use**

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

## 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 or less and 60% RH or less.

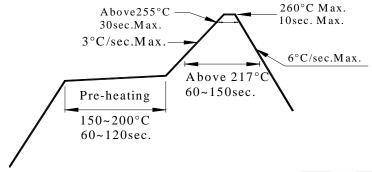
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5 for 24 hours.

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile



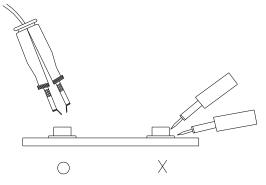
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

## 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





## **Application Restrictions**

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

